⊗TDK

Inductors for power circuits Multilayer ferrite MLP series



MLP1608 type



O A low-loss magnetic material is used so that a low-loss inductor for the power supply circuit can be achieved.

In addition to the inductance value, product types with various features are available so that they can be compatible with different usages.

Htype: this product uses a low-loss material and has low DC resistance.

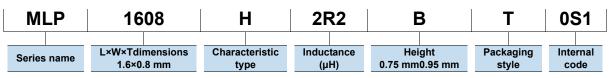
* Optimal for when heavy load power efficiency is important. Vtype : as with the H type, this product with a low-loss magnetic material and that has good DC superimposition type characteristics. * Optimal for when light load power efficiency is important.

Operating temperature range: -40 to +125°C (including self-temperature rise)

APPLICATION

Smart phones, tablet terminals, digital cameras, video cameras, HDDs, power supply modules, etc.

PART NUMBER CONSTRUCTION



CHARACTERISTICS SPECIFICATION TABLE

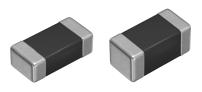
Туре		Thickness	L	Measuring frequency	DC resistance	Rated current*	Part No.
		T (mm)max.	(µH) Tolerance	(MHz)	(Ω)±30%	(mA)max.	
	Low resistance	0.95	2.20 ±20%	2	0.30	750	MLP1608H2R2BT0S1
Low core loss		0.75	0.47 ±20%	2	0.22	800	MLP1608VR47DT0S1
	Emphasized	0.75	1.00 ±20%	2	0.30	700	MLP1608V1R0DT0S1
	DC bias	0.95	0.47 ±20%	2	0.20	800	MLP1608VR47BT0S1
	characteristics	0.95	1.00 ±20%	2	0.30	700	MLP1608V1R0BT0S1
		0.95	2.20 ±20%	2	0.36	600	MLP1608V2R2BT0S1

* Rated current: current assumed when temperature has risen to 40°C max.

Measurement equipment

Measurement item	Product No.	Manufacturer		
L	4294A+16034G	Keysight Technologies		
DC resistance	Type-755611	Yokogawa		
* Equivalent measurement equipment may be used				

* Equivalent measurement equipment may be used.

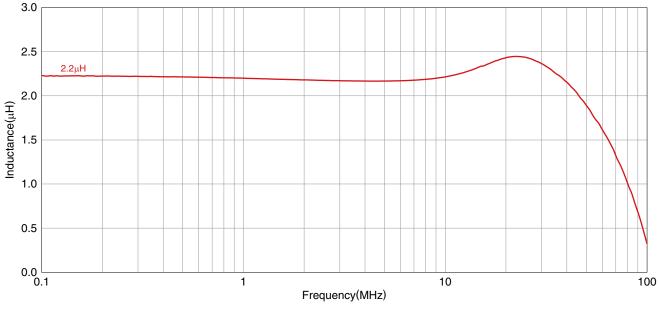


Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

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MLP1608 type (H characteristic product, T dimension of the product 0.95mm max.)

L FREQUENCY CHARACTERISTICS

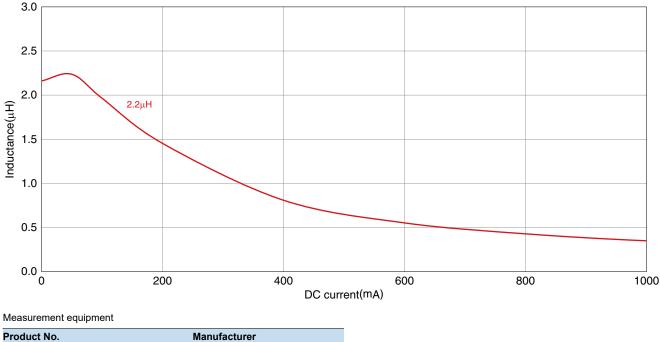


Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

* Equivalent measurement equipment may be used.

INDUCTANCE VS. DC BIAS CHARACTERISTICS



Product No.

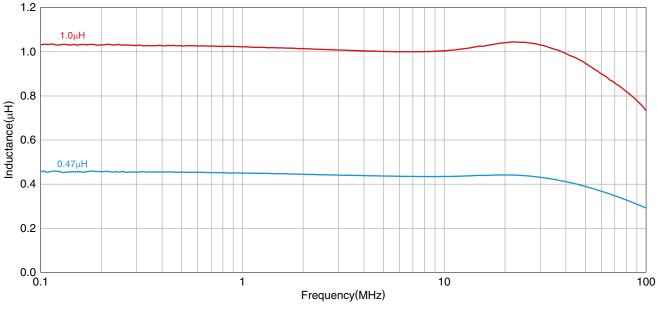
4285A+42841A+42842C+42851-61100 Keysight Technologies

* Equivalent measurement equipment may be used.

A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

MLP1608 type (V characteristic product, T dimension of the product 0.75mm max.)

L FREQUENCY CHARACTERISTICS

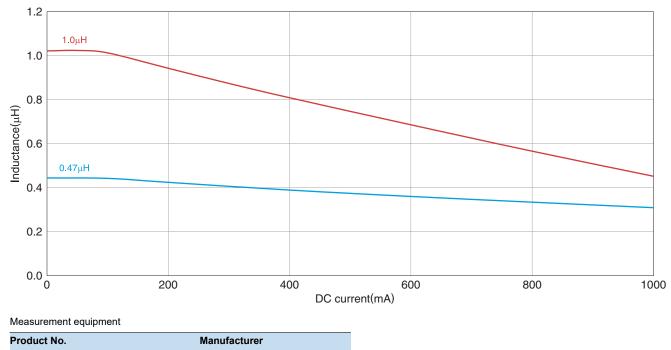


Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies
*	

* Equivalent measurement equipment may be used.

INDUCTANCE VS. DC BIAS CHARACTERISTICS



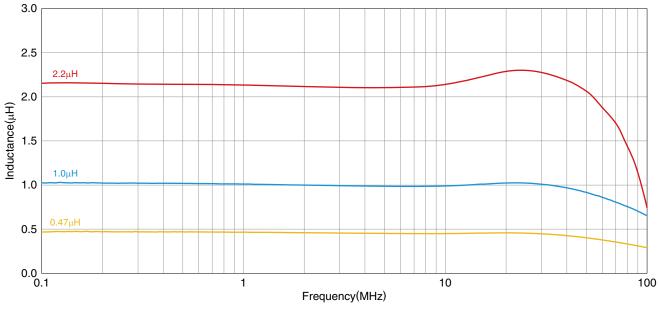
4285A+42841A+42842C+42851-61100 Keysight Technologies

* Equivalent measurement equipment may be used.

A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

MLP1608 type (V characteristic product, T dimension of the product 0.95mm max.)

L FREQUENCY CHARACTERISTICS

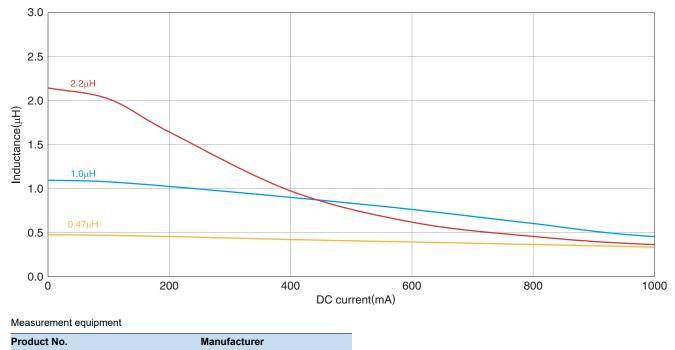


Measurement equipment

Product No.	Manufacturer
4294A+16034G	Keysight Technologies

* Equivalent measurement equipment may be used.

INDUCTANCE VS. DC BIAS CHARACTERISTICS



4285A+42841A+42842C+42851-61100 Keysight Technologies

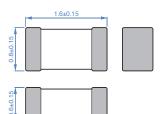
* Equivalent measurement equipment may be used.

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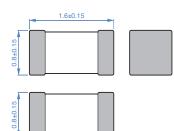
MLP1608 type

L t=0.75mm max.



0.3±0.2 □ t=0.95mm max.

0.3±0.2



RECOMMENDED LAND PATTERN

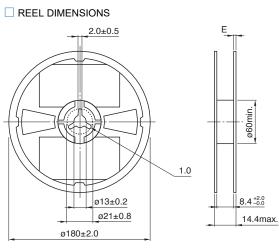
RECOMMENDED REFLOW PROFILE

			0.8
			0
0.6	0.8	0.6	

Preheating Peak 250 to 260°C 230°C 10s max. 30 to 60s

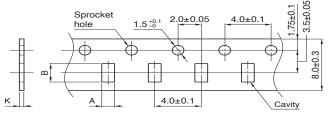
Time

PACKAGING STYLE



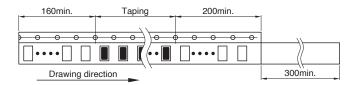
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	Α	В	К
MLP1608	1.1±0.2	1.9±0.2	1.1 max.



PACKAGE QUANTITY

Package quantity	4000 pcs/reel
Fackage quantity	4000 pcs/reer

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Туре	Operating temperature range *	Storage temperature range **	Individual weight
t=0.75mm	–40 to +125 °C	–40 to +85 °C	4 mg
t=0.95mm	–40 to +125 °C	–40 to +85 °C	5.5 mg

* Operating temperature range includes self-temperature rise.

** The storage temperature range is for after the assembly.

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20230425

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less).

If the storage period elapses, the soldering of the terminal electrodes may deteriorate.

- O Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
 The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
 If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
 A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- O Do not use for a purpose outside of the contents regulated in the delivery specifications.
- O The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment

- (7) Transportation control equipment
- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment

(13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

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